

General Description

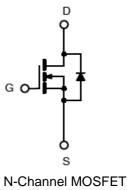
The TSM1N80 is used an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain- to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

Features

- $R_{DS(ON)}=18\Omega(Typ.) @ V_{GS}=10V, I_{D}=0.15A$
- Low gate charge @ 5nC (Typ.)
- Low Crss @ 2.7pF (Typ.)
- Fast switching

Ordering Information

Part No.	Package	Packing	
TSM1N80SCT B0	TO-92	1Kpcs / Bulk	
TSM1N80SCT A3	TO-92	2Kpcs / Ammo	
TSM1N80CW RP	SOT-223	2.5kpcs / 13" Reel	



Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	800	V		
Gate-Source Voltage		V _{GS}	±30	V	
Continuous Drain Current	I _D	0.3	А		
Pulsed Drain Current (Note 1)	I _{DM}	1	А		
Single Pulse Avalanche Energy (Note 2)		E _{AS}	90	mJ	
Avalanche Current, Repetitive or Not-Repetitive	(Note 1)	I _{AR}	1	А	
Total Power Dissipation $@T_c = 25^{\circ}C$	TO-92	р	3	W	
Total Fower Dissipation $@T_C = 25 C$	SOT-223	P _{DTOT}	2.1		
Operating Junction and Storage Temperature Ra	T _J , T _{STG}	-55 to +150	°C		
Lead Temperature (1/8" from case)		TL	10	S	

Thermal Performance

Parameter	Symbol	Limit	Unit		
Thermal Desistance Junction to Ambient	TO-92	RƏ _{JA}	130	°C/W	
Thermal Resistance - Junction to Ambient	SOT-223		60	C/W	

Notes: Surface mounted on FR4 board t \leq 10sec

Block Diagram



Electrical Specifications (Ta=25°C, unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 1mA$	BV _{DSS}	800			V	
Drain-Source On-State Resistance	$V_{GS} = 10V, I_{D} = 0.15A$	R _{DS(ON)}		18	21.6	Ω	
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \text{uA}$	V _{GS(TH)}	3		5	V	
Zero Gate Voltage Drain Current	$V_{DS} = 800V, V_{GS} = 0V$	I _{DSS}			25	uA	
Gate Body Leakage	$V_{GS} = \pm 30V, V_{DS} = 0V$	I _{GSS}			±10	uA	
Forward Transconductance	$V_{DS} = 40V, I_{D} = 0.1A$	g _{fs}		0.36		S	
Diode Forward Voltage	$I_{S} = 0.2A, V_{GS} = 0V$	V_{SD}			1.4	V	
Dynamic ^b							
Total Gate Charge		Qg		5	6		
Gate-Source Charge	$V_{DS} = 640V, I_D = 0.3A,$	Q _{qs}		1		nC	
Gate-Drain Charge	– V _{GS} = 10V	Q _{qd}		2			
Input Capacitance		C _{iss}		155	200		
Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$	C _{oss}		20	26	pF	
Reverse Transfer Capacitance	f = 1.0MHz	C _{rss}		2.7	4		
Switching ^c							
Turn-On Delay Time		t _{d(on)}		10	30		
Turn-On Rise Time	$V_{GS} = 10V, I_D = 0.3A,$	t _r		20	50		
Turn-Off Delay Time	V_{DS} = 400V, R_G = 25 Ω	t _{d(off)}		16	45	nS	
Turn-Off Fall Time		t _f		25	60		

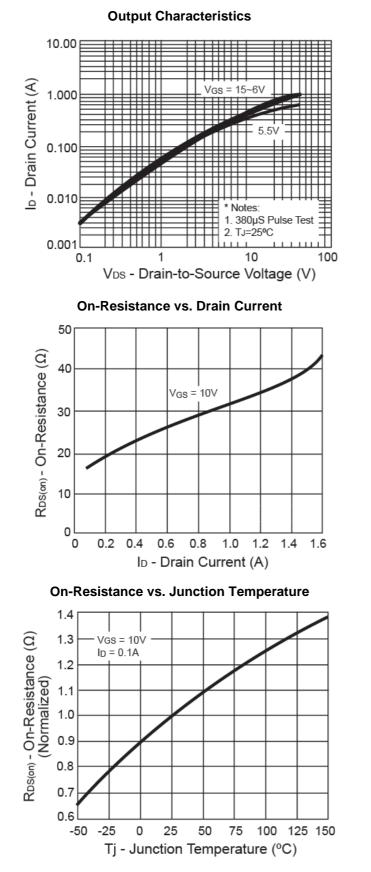
Note 1: Pulse test: pulse width <=300uS, duty cycle <=2%

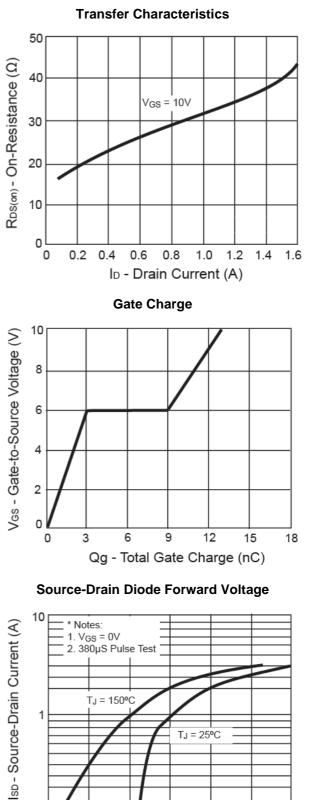
Note 2: $(V_{DD} = 50V, I_{AS} = 0.8A, L = 170mH, R_G = 25\Omega)$ **Note 3:** For design reference only, not subject to production testing.

Note 4: Switching time is essentially independent of operating temperature.



Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)





1.2

Tj = 25⁰C

1.0

1.1

0.1 0.5

0.6

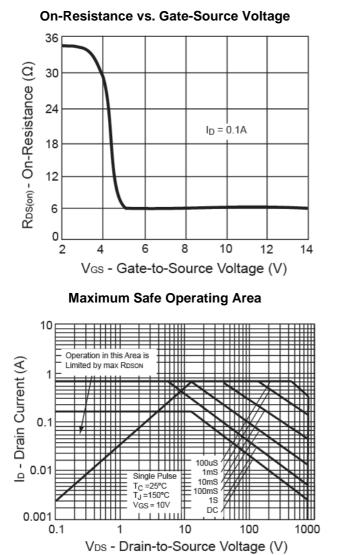
0.7

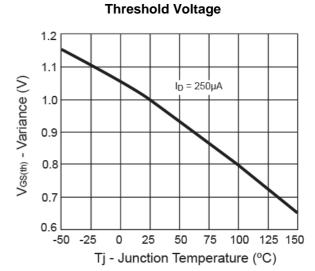
0.9

Vsp - Source-Drain Voltage (V)

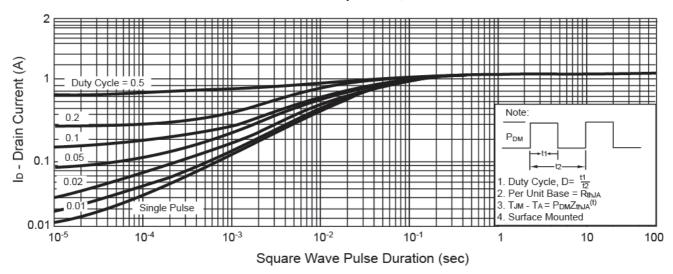


Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)



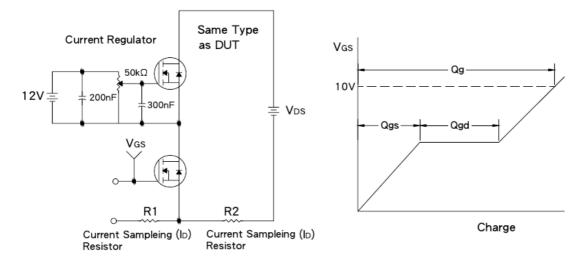


Normalized Thermal Transient Impedance, Junction-to-Ambient

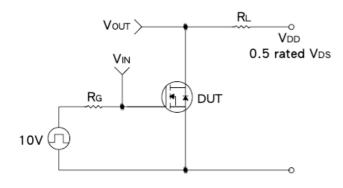


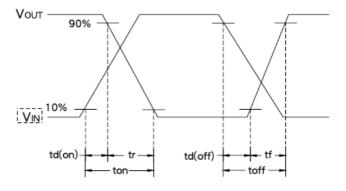


Gate Charge Test Circuit & Waveform

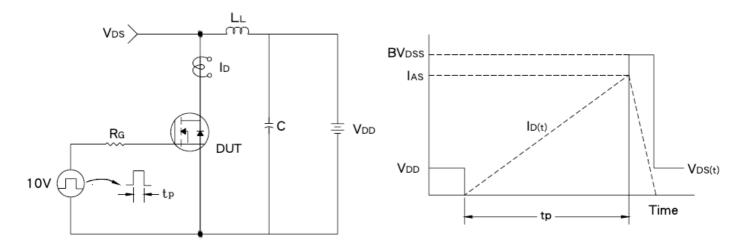


Resistive Switching Test Circuit & Waveform



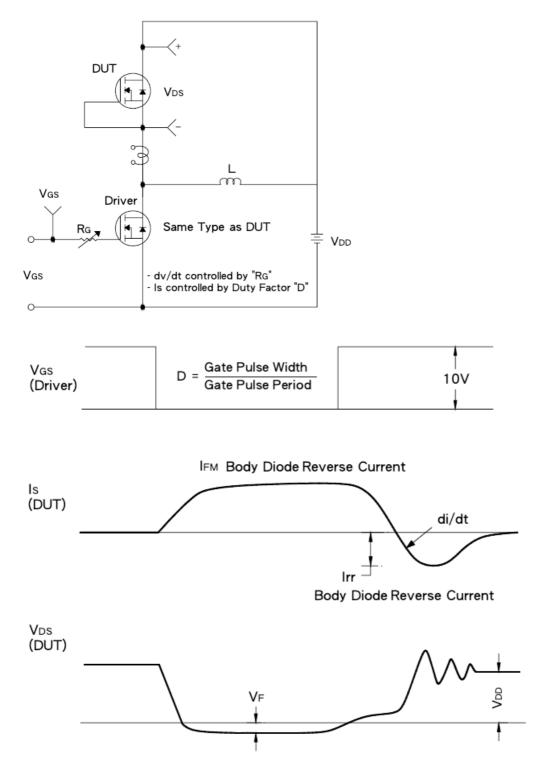


EAS Test Circuit & Waveform



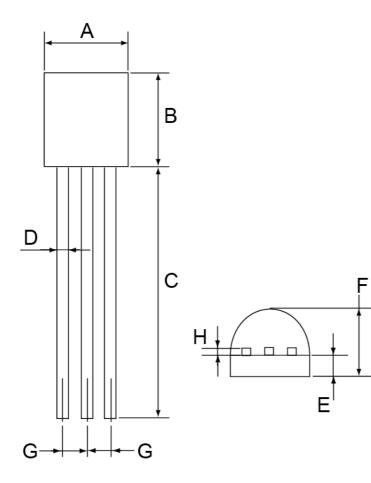


Diode Reverse Recovery Time Test Circuit & Waveform



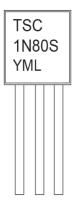


TO-92 Mechanical Drawing



TO-92 DIMENSION						
	MILLIMETERS		INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.70	0.169	0.185		
В	4.30	4.70	0.169	0.185		
С	13.53 (typ)		0.532 (typ)			
D	0.39 0.49		0.015	0.019		
Е	1.18	1.28	0.046	0.050		
F	3.30	3.70	0.130	0.146		
G	1.27	1.31	0.050	0.051		
Н	0.33	0.43	0.013	0.017		

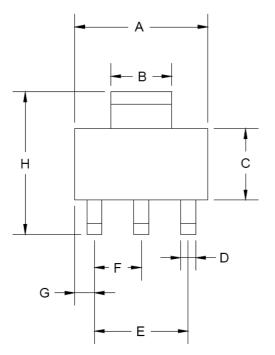
Marking Diagram

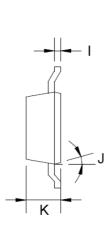


- Y = Year Code
- **M** = Month Code
 - (A=Jan, B=Feb, C=Mar, D=Apl, E=May, F=Jun, G=Jul, H=Aug, I=Sep, J=Oct, K=Nov, L=Dec)
- L = Lot Code



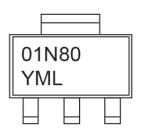
SOT-223 Mechanical Drawing





		SOT-223 DIMENSION						
	DIM	MILLIM	ETERS	INC	HES			
	DIIVI	MIN	MAX	MIN	MAX			
	А	6.350	6.850	0.250	0.270			
	В	2.900	3.100	0.114	0.122			
	С	3.450	3.750	0.136	0.148			
J	D	0.595	0.635	0.023	0.025			
	Е	4.550	4.650	0.179	0.183			
	F	2.250	2.350	0.088	0.093			
	G	0.835	1.035	0.032	0.041			
	Н	6.700	7.300	0.263	0.287			
		0.250	0.355	0.010	0.014			
	J	10°	16°	10°	16°			
	Κ	1.550	1.800	0.061	0.071			

Marking Diagram



- Y = Year Code
- **M** = Month Code

(A=Jan, B=Feb, C=Mar, D=Apl, E=May, F=Jun, G=Jul, H=Aug,
I=Sep, J=Oct, K=Nov, L=Dec)

L = Lot Code



Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.